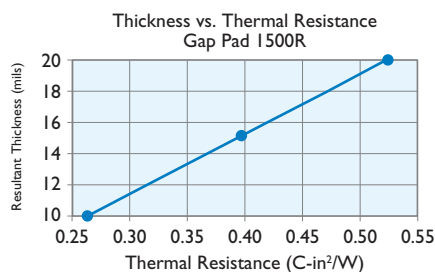




## Features and Benefits

- 

*Note: Resultant thickness is defined as the final gap thickness of the application.*



## Typical Applications Include:

- Telecommunications
- Computer and peripherals
- Power conversion
- RDRAM™ memory modules / chip scale packages
- Areas where heat needs to be transferred to a frame chassis or other type of heat spreader

### Configurations Available:

- Sheet form, die-cut parts, and roll form (converted or unconverted)

## Building a Part Number

## Standard Options

|                                              |           |           |           |           |
|----------------------------------------------|-----------|-----------|-----------|-----------|
| GPI500R - 0.020 - 02 - 00 - ACME10256 Rev. A |           |           |           |           |
| Section A                                    | Section B | Section C | Section D | Section E |

◀ example

NA = Selected standard option. If not selecting a standard option, insert company name, drawing number, and revision level.

0816 = Standard sheet size 8" x 16", or  
00 = custom configuration

02 = Natural tack, both sides

Standard thicknesses available: 0.010", 0.015", 0.020"

GP1500R = Gap Pad 1500R Material

Note: To build a part number, visit our website at [www.bergquistcompany.com](http://www.bergquistcompany.com).